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#### November 2013

# FDMS039N08B N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 100 A, 3.9 mΩ

#### Features

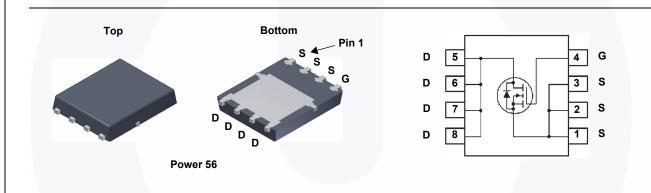
- $R_{DS(on)}$  = 3.2 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V,  $I_D$  = 50 A
- Low FOM R<sub>DS(on)</sub> \*Q<sub>G</sub>
- Low Reverse Recovery Charge, Q<sub>rr =</sub> 80 nC
- Soft Reverse Recovery Body Diode
- Enables Highly Efficiency in Synchronous Rectification
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

## Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

#### Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- · Motor drives and Uninterruptible Power Supplies



#### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol		FDMS039N08B	Unit		
V <sub>DSS</sub>	Drain to Source Voltage			80	V
V <sub>GSS</sub>	Gate to Source Voltage	urce Voltage			V
I <sub>D</sub>	Drain Current	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)	- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C)		
	Drain Current	- Continuous (T <sub>A</sub> = 25 <sup>o</sup> C)	(Note 1a)	19.4	A
DM	Drain Current	- Pulsed	(Note 2)	400	А
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 3)			240	mJ
P <sub>D</sub>	Dower Dissinction	(T <sub>C</sub> = 25 <sup>o</sup> C)			W
	Power Dissipation	$(T_{A} = 25^{\circ}C)$	(Note 1a)	2.5	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Ter	-55 to +150	°C		

### **Thermal Characteristics**

Symbol	Parameter	FDMS039N08B	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.2	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 1a)	50	°C/W

		Device	Packa	age	Reel Size	Тар	e Width		Quantit	у
=loctrica	· · · · · · ·		Power	r 56	13 "	_	2 mm		3000 units	
	I Char	racteristics T <sub>c</sub> = 2	25°C unles	s otherwis	e noted.	·				
Symbol		Parameter			Test Condition	IS	Min.	Тур.	Max.	Unit
Off Charac	teristic	S							I	1
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage		Itage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V			80	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>		down Voltage Temperature		$I_D = 250 \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$			-	0.04	-	V/ºC
I <sub>DSS</sub>	Zero G	ate Voltage Drain Current		V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V			-	-	1	μA
I <sub>GSS</sub>	Gate to	o Body Leakage Current		V <sub>GS</sub> =	±20 V, V <sub>DS</sub> = 0 V		-	-	±100	nA
On Charac	teristic	S								
V <sub>GS(th)</sub>	_	Threshold Voltage		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA			2.5	-	4.5	V
R <sub>DS(on)</sub>		Drain to Source On Resistance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 50 \text{ A}$			-	3.2	3.9	mΩ
9FS	Forwar	rward Transconductance			10 V, I <sub>D</sub> = 50 A		-	100	-	S
Dynamic C	haract	eristics								
C <sub>iss</sub>	1	apacitance					-	5715	7600	pF
C <sub>oss</sub>		Capacitance	-	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V f = 1 MHz		-	881	1170	pF	
C <sub>rss</sub>	Revers	e Transfer Capacitance		T = 1 IV	IHZ	·	-	15	-	pF
C <sub>oss</sub> (er)		Releted Output Capacita	nce	V <sub>DS</sub> =	40 V, V <sub>GS</sub> = 0 V		-	1646	-	pF
Q <sub>g(tot)</sub>	Total G	ate Charge at 10V		V <sub>DS</sub> =	40 V, I <sub>D</sub> = 50 A		-	77	100	nC
Q <sub>gs</sub>	Gate to	Source Gate Charge		$V_{GS} = 0 V \text{ to } 10 V$		-	34	-	nC	
Q <sub>gs2</sub>	Gate C	harge Threshold to Plate	eau				-	13	-	nC
Q <sub>gd</sub>	Gate to	Drain "Miller" Charge				(Note 4)	-	16	-	nC
ESR	Equival	ent Series Resistance		f = 1 N	IHz		-	1.2	-	Ω
Switching	Charac	teristics								
t <sub>d(on)</sub>	Turn-O	n Delay Time					-	42	94	ns
t <sub>r</sub>	Turn-O	n Rise Time			$V_{DD}$ = 40 V, I <sub>D</sub> = 50 A V <sub>GS</sub> = 10 V, R <sub>G</sub> = 4.7 Ω		-	25	60	ns
t <sub>d(off)</sub>	Turn-Of	ff Delay Time		V <sub>GS</sub> =			-	48	106	ns
t <sub>f</sub>	Turn-Of	ff Fall Time		(Note 4)		(Note 4)	-	17	44	ns
Drain-Sour	rce Dio	de Characteristics	;							
I <sub>S</sub>	Maximu	um Continuous Drain to Source Diode Forward Current				-	-	100	Α	
I <sub>SM</sub>	Maximu	Im Pulsed Drain to Source Diode Forward Current			-	-	400	Α		
V <sub>SD</sub>	Drain to	Source Diode Forward	Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 50 A			-	-	1.3	V
t <sub>rr</sub>	Reverse	e Recovery Time			0 V, I <sub>SD</sub> = 50 A, V <sub>D</sub>	<sub>DD</sub> = 40 V	-	68	/ -	ns
Q <sub>rr</sub>	Reverse	e Recovery Charge			= 100 A/µs		-	80	-	nC

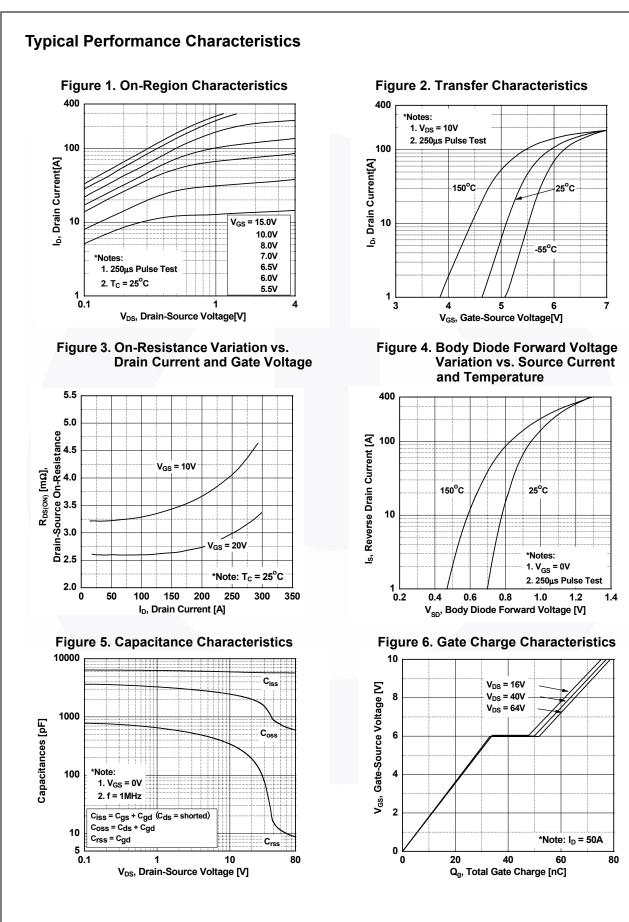
2. Repetitive rating: pulse-width limited by maximum junction temperature.

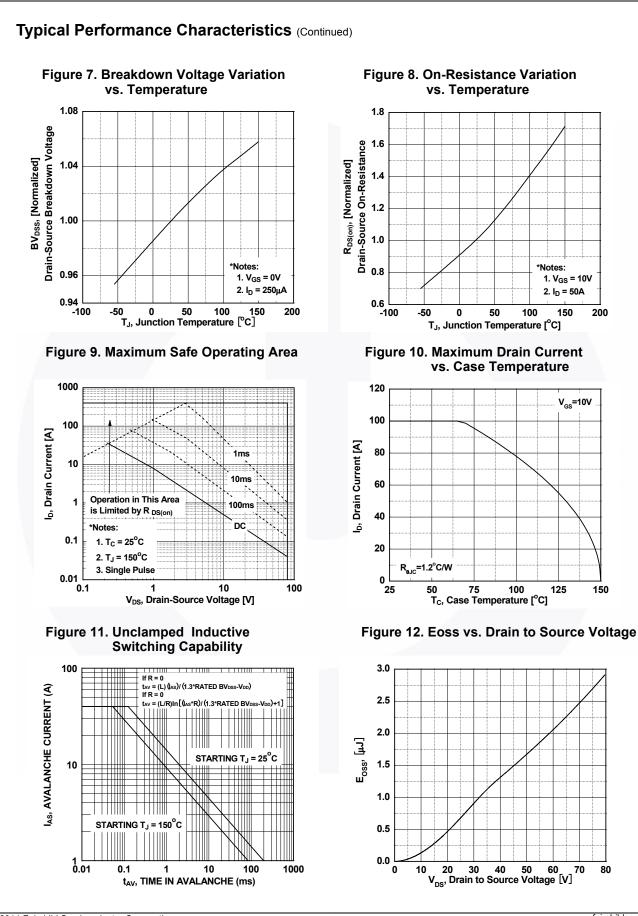
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3. L = 0.3 mH,  $I_{AS}$  = 40 A, starting  $T_J$  = 25°C.

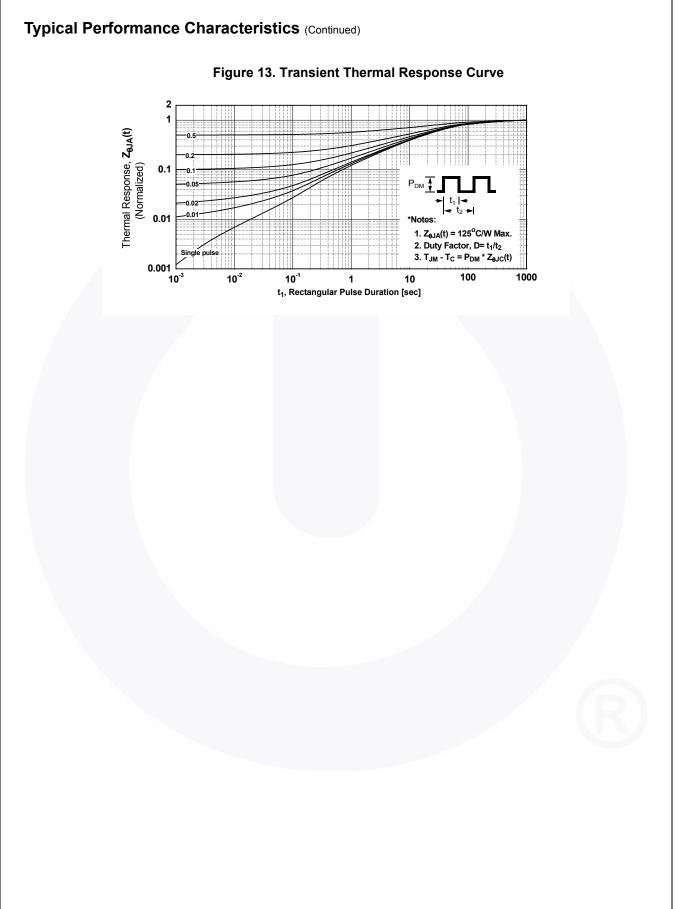
4. Essentially independent of operating temperature typical characteristics.

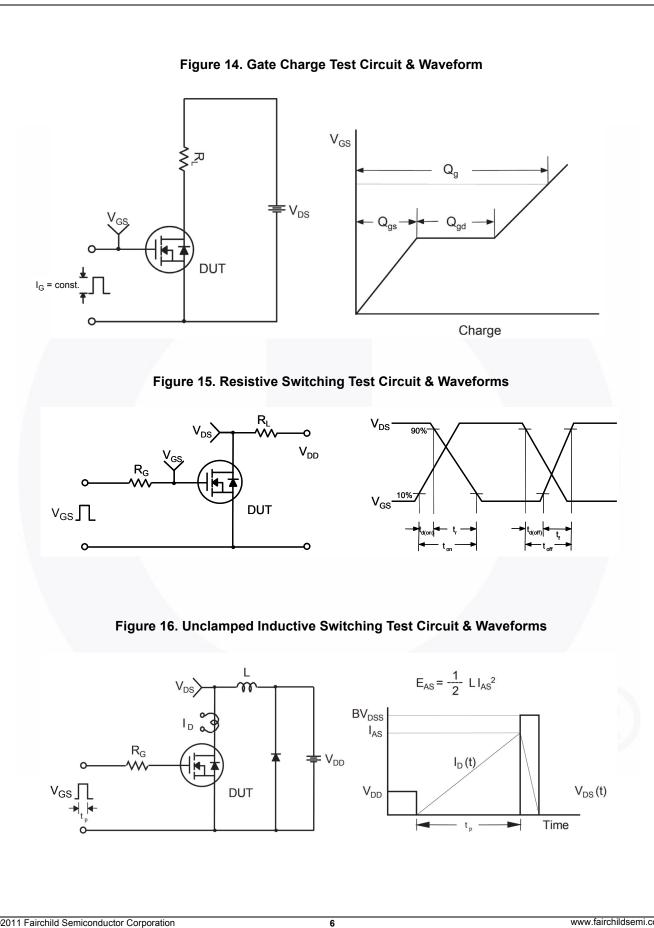
FDMS039N08B — N-Channel PowerTrench<sup>®</sup> MOSFET





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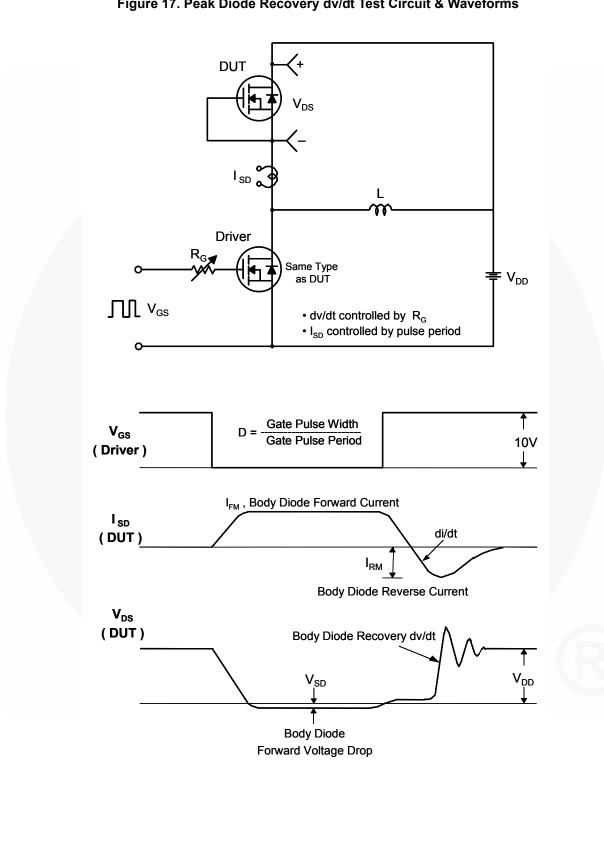
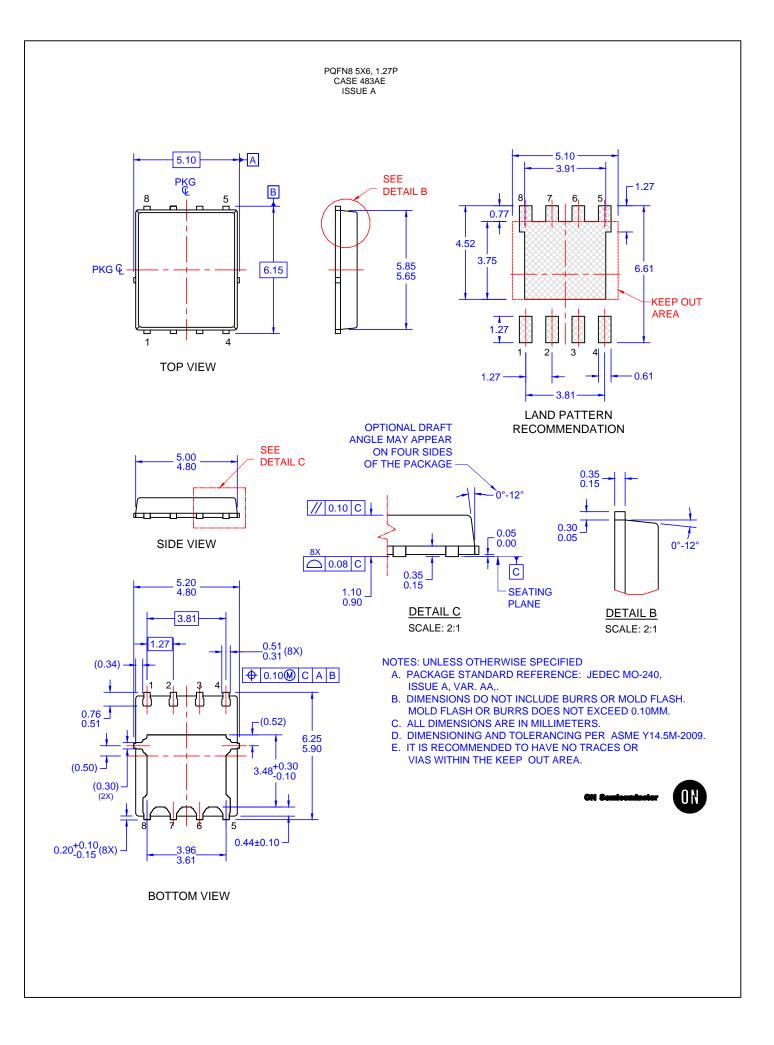


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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